

# **SPECIFICATION**

Revision: 0.0

### WKS43WV025-WCT

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY
Jason	Eric	Sandy

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## **REVISION RECORD**

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2022-4-9	First release	Preliminary

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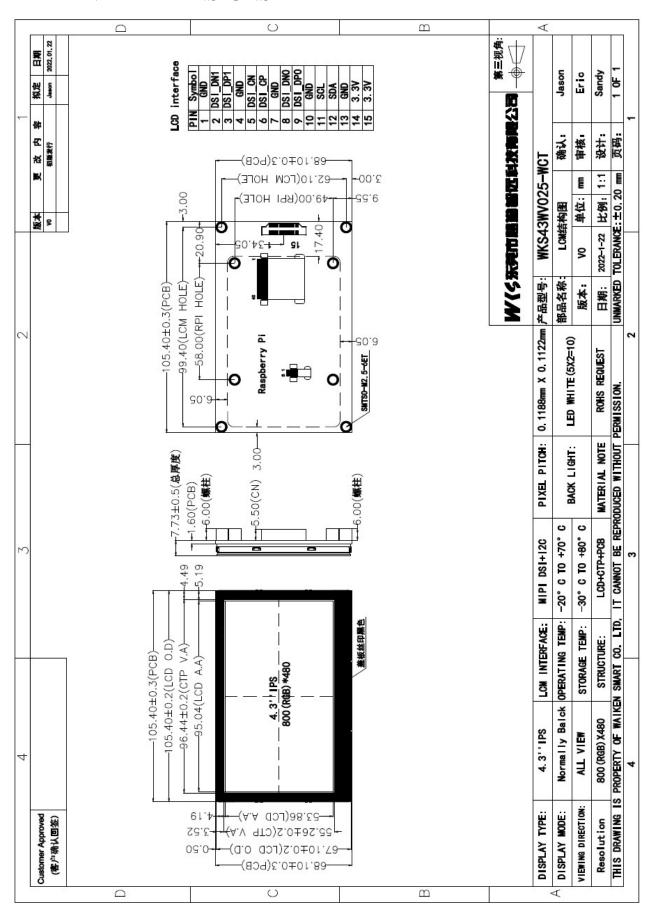
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Item of general information	Contents	Unit
LCD Display Size (Diagonal)	4.3	inch
LCD Display Type	TFT/TRANSMISSIVE	-
LCD Display Mode	Normally Black	-
Recommended Viewing Direction	ALL VIEW	o'clock
LCM Module size (W×H×T)	105.40×68.10×7.73	mm
Active area (W×H)	95.04×53.86	mm
Number of pixels (Resolution)	800×480	pixel
Pixel pitch (W×H)	0.1188×0.1122	mm
Color Pixel Arrangement	RGB Stripe	-
Interface Type	MIPI DSI interface	-
Color Numbers	16.7M	-
Backlight Type	White LED	-

## 2. EXTERNAL DIMENSIONS





### 3, ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
LCD supply voltage	VDD	-0.5	5.0	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings mean the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

## 4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage	VDD	-	3.3	-	V	

#### **5. CTP CHARACTERISTICS**

Item of CTP	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	$800 \times 480$	pixel	-
Surface Hardness	6Н	-	-
Interface Type	I2C	-	-
Support Points	5	-	-



### **6**, ELECTRO-OPTICAL CHARACTERISTICS

Item of electro-optical characteristics		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf		_	30	40	ms	FIG 1.	4
Contrast I		CR	$\theta=0$	640	800	_	-	FIG 2.	1
Luminance un	iformity	<i>SWHITE</i>	$\mathcal{D}=0$ $Ta=25^{\circ}C$	-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv	1 <i>u</i> -2 <i>5</i> C	-	350	-	cd/m2	FIG 2.	2
	1171 : ,	White x		0.309	0.313	0.315			
	White	White y		0.337	0.339	0.341			
	D 1	Red x		0.629	0.631	0.633			
CIE(x, y)	Red $\theta = 0$		0.327	0.329	0.331		FIG 2.	_	
chromaticity	Cuan	Green x	$\mathcal{D}=0$ $Ta=25^{\circ}C$	0.326	0.328	0.330	] -	FIG 2.	5
	Green	Green y	14 23 C	0.546	0.548	0.550			
	DI.	Blue x		0.134	0.136	0.138			
	Blue	Blue y		0.139	0.141	0.143			
	Ø=90(1	2 o'clock)		70	80	-	deg		
Viewing	Ø=270	(6 o'clock)	CR ≥ 10	70	80		deg	FIG 3.	6
angle range			CK ≥ 10	70	80	-	deg	FIG 3.	6
	Ø=180 <sub>0</sub>	(9 o'clock)		70	80	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

**Note 1.** Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$ 

**Note 2.** Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance ( $\delta$ WHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of

9points luminance by minimum luminance of 9 points luminance. For more information see FIG 2.

$$\delta \text{WHITE} = \frac{\textit{Minimum Surface Luminance with all white pixels}(P1, P2, P3, P4, P5, P6, P7, P8, P9)}{\textit{Maximum Surface Luminance with all white pixels}(P1, P2, P3, P4, P5, P6, P7, P8, P9)}$$

**Note 4.** Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1.

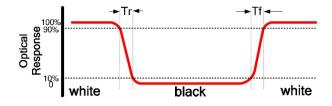
**Note 5.** CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

**Note 6.** Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

**Note 7.** For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

**Note 8.** For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

## FIG.1. The definition of Response Time



### FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance

## uniformity, CIE (x, y) chromaticity

A: H/6; B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

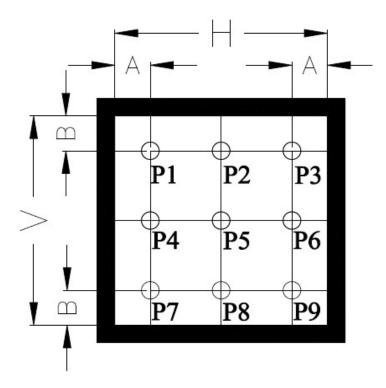
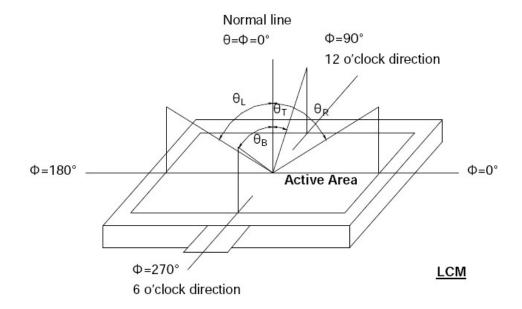


FIG.3. The definition of viewing angle



## 7. INTERFACE DESCRIPTION

NO.	Symbol	I/O	DESCRIPTION
1	GND	Power	Ground
2	DSI_DN1	I	MIPI DSI data1-
3	DSI_DP1	I	MIPI DSI data1+
4	GND	Power	Ground
5	DSI_CN	I	MIPI DSI clock-
6	DSI_CP	I	MIPI DSI clock+
7	GND	Power	Ground
8	DSI_DN0	I	MIPI DSI data0-
9	DSI_DP0	I	MIPI DSI data0+
10	GND	Power	Ground
11	SCL	I	I2C data input and output for TOUCH
12	SDA	I/O	I2C clock input for TOUCH
13	GND	Power	Ground
14	3.3V	Power	3.3V Power Input
15	3.3V	Power	3.3V Power Input



### 8, RELIABILITY TEST CONDITIONS

No.	Test Item Test Condition					
1	High Temperature Storage	80°C/120 hours				
2	Low Temperature Storage	-30°C/120 hours				
3	High Temperature Operating	70°C/120 hours				
4	Low Temperature Operating	-20°C/120 hours				
5	Temperature Cycle Storage	-20°C(30min.)~25(5min.)~70°C(30min.)×10cycles				

### A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- Air bubble in the LCD;
- Sealleak;
- ➤ Non-display;
- Missing segments;
- Glass crack;
- > Current is twice higher than initial value.

#### B, Remark:

- ➤ The test samples should be applied to only one test item.
- Sample size for each test item is  $5\sim10$  pcs.
- ➤ Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

Apr 9, 2022



#### 9. INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

#### Sample plan 9.1

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

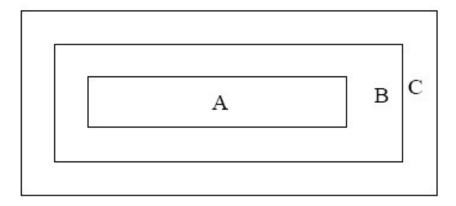
Minor defect: AQL 1.5

#### 9.2 **Inspection condition**

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25°C and normal humidity 60 ±15%RH)

#### **Definition of Inspection Item.** 9.3

#### Definition of inspection zone in LCD. A,



Zone A: character/Digit area



Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

### **B**, Definition of some visual defect

	Because of losing all or part function, bad pixel dots appear bright and the					
Bright dot	size is more than 50% of one dot in which LCD panel is displaying under					
	black pattern.					
Doub dot	Dots appear dark and unchanged in size in which LCD panel is displaying					
Dark dot	under pure red, green, blue picture, or pure whiter picture.					

#### 9.4 Major Defect

Item No.	Items to be inspected	Inspection standard	Classification of defects
1	Functional defects	<ol> <li>No display</li> <li>Display abnormally</li> <li>Missing vertical, horizontal segment</li> <li>Short circuit</li> <li>Excess power consumption</li> <li>Backlight no lighting, flickering and abnormal lighting</li> </ol>	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

## 9.5. Minor Defect

Item No.	Items to be inspected		Inspection standard						Classification of defects	
			Zone			Accept	able Qty			
						A+B			1	
					4.3~	7" 7~10.1	" >10.1"	С	•	
		Br	ight pixel do	t	1	2	3		1	
	Bright dot	D	ark pixel dot		4	4	4	Aco		
1	/dark dot	2brigh	nt dots adja	cent	0	0	0	Acceptable	Minor	
	defect	2darl	dots adjac	ent	0	0	0	able		
		Total bri	ght and da	rk dots	5	6	7			
		Note: Mir	nimum dist	ance bet	ween o	defective dot	s is more th	an 5mm		
		Pixel dots	' function	is norma	ıl, but	bright dots ca	aused by for	eign		
		material a	nd other re	asons ar	e judg	ged by the dot	defect of 5	.2.		
			Zone			Acceptable	Qty			
					A+B					
		Size(mm		4.3"~	-7"	7~10.1"	>10.1"	С		
	Dot defect	Dot defect	Ф \$	≤0.2	Accept	table	Acceptable	Acceptabl	Acc	
2	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		Ф≤0.5	4		5	6	Acceptable	Minor	
	<b>←</b> →	Φ >	>0.5	0		0	0	le		
	$\Phi = (x+y)/2$	Note:  1. Minimum distance between defective dots is more than 5 mm  2. The quantity of defect is zero in operating condition.						mm;		
			Zone			Acceptable	Qty		]	
		Size (mr	n)			A+B	1		1	
3	Linear	Length	Width	4.3"~	~7"	7~10.1"	>10.1"	С	Minor	
3	defect	Ignore	W≤0.05	Accept	table	Acceptable	Acceptabl	le 🎽	IVIIIIOI	
		L≤5.0	0.05 < W≤0.1	4		5	6	Acceptable		
		L>5.0	W>0.1	0		0	0	le		

W(s	TOUCH N	MODULE	W	KS43WV02	5-WCT	Revision	0.0:	Apr 9, 2022
4	Polarizer defect	dimension. (ii) Incomallowed. 5.4.2 Dirt of Dirt which 5.4.3 Polar  Size(mm) $\Phi \leq 0.2 < \Phi$ $0.2 < \Phi$ $0.1 f the porin the of (ii) If the condition  Size (mm)  Length  Ignore  1.0 < L  < 5.0$	in position in polarization pol	ering of the vier iped easily shows Air bubble 4.3"~7" Acceptable 4	Acceptable  A+B  7~10.1"  Acceptable  5  0  e seen after cadge by the libe seen only	able.  Qty  >10.1"  Acceptable  6  0  cover assembnear defect of in non-operate following:	C Acceptable ling of 5.3.	Minor
5	MURA	Using 3% ND filter, it's NG if it can be seen in R,G,B picture.						
	White/Black dot (MURA)	Visible under: ND3%; D $\leq$ 0.15mm, Acceptable; 0.15mm <d<math>\leq0.5mm, N<math>\leq</math>4; D&gt;0.5mm, Not allowable.</d<math>						Minor

W(S	TOUCH	MODULE	WKS43V	WV025-WCT	Revision:0.0	Apr 9, 2022	
	Glass defect	(i) Crack Cracks are	Minor				
6		$\begin{array}{ c c }\hline X\\ \leqslant 3.0\\ \hline \text{Chips on the} \end{array}$	Not more than the				
		into the ITO  (iii) Usual su  X  ≤1.5	Minor				



Item No.	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	Not allowable	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3		No soldering missing	Major
	Soldering defects	No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on PCB	Visible copper foil (Φ0.5 mm or more) on substrate pattern is not allowed	Minor
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed $\Phi$ 0.2mm)	Minor
9	Stain	No stain to spoil cosmetic badly	Minor
10	Plate discoloring	No plate fading, rusting and discoloring	Minor
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor
	1	b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
11	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor
	3. Chips	(3/2) H ≥h ≥(1/2) H  \$\square\$\tag{\hat{h}} \hat{H}\$	Minor
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad h $\geq$ 0.13 mm. The diameter of solder ball d $\leq$ 0.15 mm.	Minor
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major